



COMPAL ELECTRONICS, INC.	
PROJECT	DAZ20
BOARD NO.	LA-F312P REV:2.0(A01)
LAYER NO.	SOLDEMASK_TOP
DRAW BY	SF
Issued Date	2018-01-08
Security level	Confidential
Decipherment date	2019-01-08

Decipherment date	2019-01-08
Security level	Confidential
Issued Date	2018-01-08
DRAW BY	2F
LAYER NO.	SOLDERMASK_BOTTOM
BOARD NO.	LA-F313P REV:5.0(A01)
PROJECT	DAS250
COMPAL ELECTRONICS, INC.	

